

TECHNICAL DATA SHEET EPA3082 Clear

8/09/2021

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DESCRIPTION:

Tacusil EPA3082 Clear is a two part unfilled epoxy encapsulant designed for medium sized castings. It cures at room temperature to a tough and flexible polymer. It has good wetting and adhesion to most surfaces and is free flowing to penetrate voids and give good air release and a smooth high gloss surface. It has very good resistance to water, acids and bases and most organic solvents. Thermal shock and cycling properties are enhanced by its high elongation giving it the ability to absorb differences in CTE's of substrates and potted components.

TYPICAL PROPERTIES:

All properties given are at 25 °C unless otherwise noted.

Property:	Value:	Test Method or Source:
Color	Clear	Visual
Mix Ratio	Part A to Part B	Calculated
By weight	1.17 to 1	
By volume	1 to 1	
Cure Schedule	24-48 hours @ 25 °C	
	1 hour @65 °C	
	20 minutes @100 °C	
Viscosity – Part A	5000 cps	Rheometer parallel plate 25mm@1/s
Viscosity – Part B	2,000 cps	
Viscosity - Mixed	3,000 cps	
Specific Gravity - Mixed	1.06	Calculated
Pot Life, defined as the time it takes for initial mixed viscosity to double	1 hour	Rheometer parallel plate 25mm@1/s
Glass Transition Temperature/Tg	25 °C	by DSC
Hardness	50 Shore D	ASTM D2240
Water Absorption	0.66% after 24 hours	ASTM D570
Tensile Properties:		ASTM D638
Strength	2,400 psi	Extrapolated from Resinlab EP1282
Elongation	100%	·



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Lap Shear Strength		ASTM D1002
0.010" bond line Al to Al	1,500 psi	Extrapolated from Resinlab EP1282
Surface Resistivity	1.4 x 10 ¹⁶ ohm/sq (@ 20 %RH)	ASTM D257
Volume Resistivity	1.3 x 10 ¹⁴ ohm-cm (@ 24 °C)	Extrapolated from EP1282 Clear
Dielectric Constant / Dissipation Factor		ASTM D150
@ 100 Hz	4.1, 0.070	Extrapolated from EP1282 Clear
@ 100 kHz	3.3, 0.040	
AC Dielectric Strength	770 V/mil (30.5 kV/mm)	ASTM D149 Method A, tested in oil
		Extrapolated from EP1282 Clear
Temperature Range	-40 to 150 °C**	

^{*} Asterisk denotes values considered typical to associated resin systems or extrapolated from other test results.

INSTRUCTIONS:

- 1. Bring both components to room temperature prior to mixing. Cartridges should be stored in a vertical position to allow any air to accumulate at the tip.
- 2. Cartridge format: Mixer should be attached keeping the cartridge vertical and any air pocket purged this way. After the mixer contains material, the mixer tip can be dropped to dispense pre-bleed amount. Attach a new static mixer with each cartridge, then pre-bleed the first 3 inches of dispensed material or until a uniform color is obtained. Maintain adequate velocity during dispensing to ensure complete mixing.
- 3. Bulk format: weigh and mix parts A and B accurately and thoroughly, scraping sides of container often. Do not pour from mixing container, transfer to a new container as residual unmixed material may cause a tacky spot on the surface of the casting. Maintain adequate velocity during dispensing to ensure complete mixing.
- 4. Allow to cure undisturbed until product is fully gelled or tack-free to the touch.
- 5. Clean up uncured resin with suitable organic solvent such as MEK, acetone or other organic solvent.

SHELF LIFE AND STORAGE: 12 months at 25 °C

Specialty packaging may be less.

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^{**}Temperature rating is based on average design requirements and is not intended as a guarantee of suitability for all applications operating at that temperature.

*** This TDS contains values that have been updated. The values reported in this technical data sheet are typical values of the product, and are highly dependent on test conditions and methodology. We actively seek the most precise and accurate ways to measure and interpret performance of our products, and to update estimated values with measured values. The formula has not been revised or changed in any way. Although the values on paper have changed, you can expect the same performance of the product.



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Many epoxy resin systems are prone to crystallization as epoxy resin is a super-cooled fluid. This condition may give the product a gritty or grainy appearance (or hazy in clear products). Products in this state will not usually cure to normal and expected properties. In extreme cases it may appear solid and cured. Fluctuating temperatures (within 5 to 50 °C) aggravate this phenomenon. Heating the individual component to 50 to 60 °C while stirring can usually restore products to original state. Storage at 25 +/- 10 °C is optimum for most products.